Universal Hexadecimal Counter

The MC10H136 is a high speed synchronous hexadecimal counter. This 10H part is a functional/pinout duplication of the standard MECL 10K family part, with 100% improvement in counting frequency and no increase in power-supply current.

- Counting Frequency, 250 MHz Minimum
- Power Dissipation, 625 mW Typical
- Improved Noise Margin 150 mV (Over Operating Voltage and Temperature Range)
- Voltage Compensated
- MECL 10K-Compatible

FUNCTION SELECT TABLE

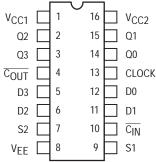
CĪN	S1	S2	Operating Mode
Х	L	L	Preset (Program)
L	L	Н	Increment (Count Up)
Н	L	Н	Hold Count
L	Н	L	Decrement (Count Down)
Н	Н	L	Hold Count
Х	Н	Н	Hold (Stop Count)

SEQUENTIAL TRUTH TABLE *

	INPUTS					OUTPUTS						
S1	S2	D0	D1	D2	D3	Carry In	Clock * *	Q0	Q1	Q2	Q3	Carry Out
L	L	L	L	Н	Н	Χ	Н	L	L	Н	Н	L
L	Н	Х	Х	Х	Х	L	Н	Н	L	Н	Н	н
L	Н	Х	Х	Х	Х	L	Н	L	Н	Н	Н	н
L	Н	Х	Х	Χ	Χ	L	Н	Н	Н	Н	Н	L
L	Н	Х	Х	Χ	Х	Н	L	Н	Н	Н	Н	Н
L	Н	Х	Х	Х	Х	Н	Н	Н	Н	Н	Н	н
Н	Н	Х	Χ	Х	Х	Х	Н	Н	Н	Н	Н	Н
L	L	Н	Н	L	L	Χ	Н	Н	Н	L	L	L
Н	L	Х	Х	Х	Х	L	Н	L	Н	L	L	Н
Н	L	Х	Х	Х	Х	L	Н	Н	L	L	L	Н
Н	L	Х	Χ	Х	Х	L	Н	L	L	L	L	L
Н	L	Χ	Х	Х	Χ	L	Н	Н	Н	Н	Н	Н

^{*} Truth table shows logic states assuming inputs vary in sequence shown from top to bottom.
** A clock H is defined as a clock input transition from a low to a high logic level.

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package. For PLCC pin assignment, see the Pin Conversion Tables on page 18 of the ON Semiconductor MECL Data Book (DL122/D).



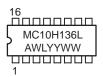
ON Semiconductor

http://onsemi.com

MARKING DIAGRAMS

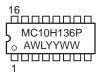


CDIP-16 **L SUFFIX CASE 620**





PDIP-16 **P SUFFIX CASE 648**





PLCC-20 **FN SUFFIX CASE 775**



= Assembly Location

WL = Wafer Lot YY = Year

WW = Work Week

ORDERING INFORMATION

Device	Package	Shipping
MC10H136L	CDIP-16	25 Units/Rail
MC10H136P	PDIP-16	25 Units/Rail
MC10H136FN	PLCC-20	46 Units/Rail

MAXIMUM RATINGS

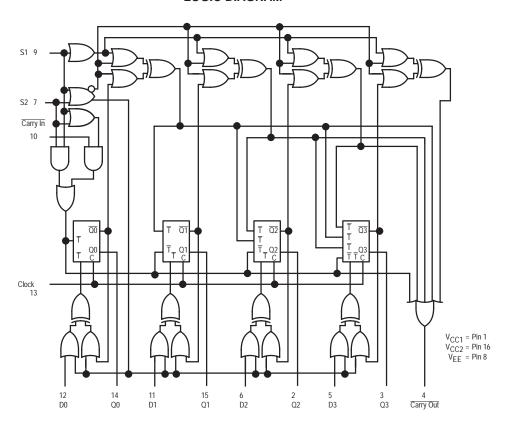
Symbol	Characteristic	Rating	Unit
VEE	Power Supply (V _{CC} = 0)	-8.0 to 0	Vdc
VI	Input Voltage (V _{CC} = 0)	0 to V _{EE}	Vdc
l _{out}	Output Current – Continuous – Surge	50 100	mA
TA	Operating Temperature Range	0 to +75	°C
T _{stg}	Storage Temperature Range – Plastic – Ceramic	−55 to +150 −55 to +165	°C °C

ELECTRICAL CHARACTERISTICS (VFF = -5.2 V ±5%) (See Note 1.)

		0 °		25 °		75°		
Symbol	Characteristic	Min	Max	Min	Max	Min	Max	Unit
ΙΕ	Power Supply Current	_	165	_	150	-	165	mA
linH	Input Current High Pins 5, 6, 11, 12, 13 Pin 9 Pin 7 Pin 10	- - - -	430 670 535 380		275 420 335 240		275 420 335 240	μА
l _{inL}	Input Current Low	0.5	_	0.5	_	0.3	-	μΑ
Voн	High Output Voltage	-1.02	-0.84	-0.98	-0.81	-0.92	-0.735	Vdc
Vol	Low Output Voltage	-1.95	-1.63	-1.95	-1.63	-1.95	-1.60	Vdc
VIH	High Input Voltage	-1.17	-0.84	-1.13	-0.81	-1.07	-0.735	Vdc
V _{IL}	Low Input Voltage	-1.95	-1.48	-1.95	-1.48	-1.95	-1.45	Vdc
AC PARAN	METERS							
^t pd	Propagation Delay Clock to Q Clock to Carry Out Carry in to Carry Out	0.7 1.0 0.7	2.3 4.8 2.5	0.7 1.0 0.7	2.4 4.9 2.6	0.7 1.0 0.7	2.5 5.0 2.7	ns
^t set	Set-up Time Data (D0 to C) Select (S to C) Carry In (C _{in} to C) (C to C _{in})	2.0 3.5 2.0 0	- - - -	2.0 3.5 2.0 0	- - - -	2.0 3.5 2.0 0	- - - -	ns
^t hold	Hold Time Data (C to D0) Select (C to S) Carry In (C to C _{in}) (C _{in} to C)	0 -0.5 0 2.2	- - - -	0 -0.5 0 2.2	- - - -	0 -0.5 0 2.2	- - - -	ns
fcount	Counting Frequency	250	-	250	-	250	-	MHz
t _r	Rise Time	0.5	2.3	0.5	2.4	0.5	2.5	ns
t _f	Fall Time	0.5	2.3	0.5	2.4	0.5	2.5	ns

^{1.} Each MECL 10H series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to –2.0 volts.

LOGIC DIAGRAM



NOTE: FLIP-FLOPS WILL TOGGLE WHEN ALL $\overline{\mathsf{T}}$ INPUTS ARE LOW.

APPLICATION INFORMATION

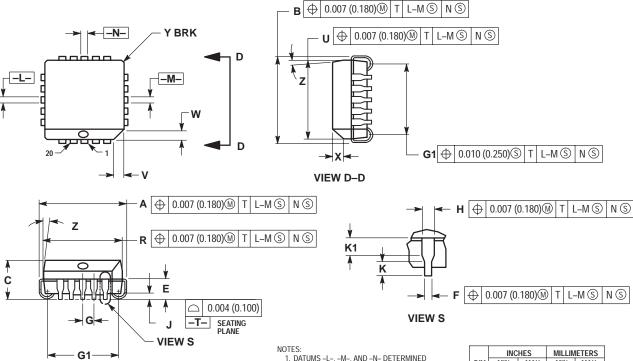
The MC10H136 is a high speed synchronous counter that operates at 250 MHz. Counter operating modes include count up, count down, pre-set and hold count. This device allows the designer to use one basic counter for many applications.

The S1, S2, control lines determine the operating modes of the counter. In the pre-set mode, a clock pulse is necessary to load the counter with the information present on the data inputs (D0, D1, D2, and D3). Carry out goes low on the terminal count or when the counter is being pre-set.

PACKAGE DIMENSIONS

PLCC-20 **FN SUFFIX**

PLASTIC PLCC PACKAGE CASE 775-02 ISSUE C



⊕ 0.010 (0.250)⑤ T L-M ⑤ N ⑤

- DATUMS -L-, -M-, AND -N- DETERMINED
 WHERE TOP OF LEAD SHOULDER EXITS PLASTIC WILLY LOVE LEAD STOUDER EXTENSIVE SOLUTION TO BE MEASURED AT DATUM -T-, SEATING PLANE.

 3. DIMENSIONS R AND U DO NOT INCLUDE MOLD
- FLASH. ALLOWABLE MOLD FLASH IS 0.010 (0.250) PER SIDE.
 4. DIMENSIONING AND TOLERANCING PER ANSI

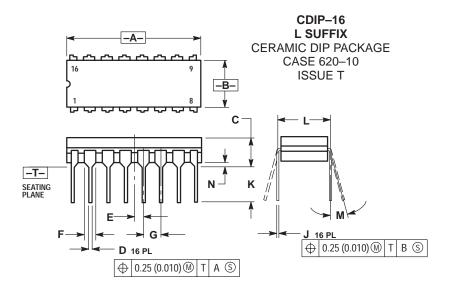
- 714.5M, 1982.

 5. CONTROLLING DIMENSION: INCH.

 6. THE PACKAGE TOP MAY BE SMALLER THAN THE PACKAGE BOTTOM BY UP TO .012 (0.300). DIMENSIONS R AND U ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY EXCLUSIVE OF MOLD FLASH, TIE BAR BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN THE TOP AND BOTTOM OF THE PLASTIC BODY.
- DIMENSION H DOES NOT INCLUDE DAMBAR PROTRUSION OR INTRUSION. THE DAMBAR PROTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE GREATER THAN 0.037 (0.940). THE DAMBAR INTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE SMALLER THAN 0.025 (0.635).

	INC	HES	MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.385	0.395	9.78	10.03
В	0.385	0.395	9.78	10.03
С	0.165	0.180	4.20	4.57
Ε	0.090	0.110	2.29	2.79
F	0.013	0.019	0.33	0.48
G	0.050	BSC	1.27	BSC
Н	0.026	0.032	0.66	0.81
J	0.020		0.51	
K	0.025		0.64	
R	0.350	0.356	8.89	9.04
U	0.350	0.356	8.89	9.04
٧	0.042	0.048	1.07	1.21
W	0.042	0.048	1.07	1.21
Х	0.042	0.056	1.07	1.42
Υ		0.020		0.50
Z	2°	10 °	2 °	10 °
G1	0.310	0.330	7.88	8.38
K1	0.040		1.02	

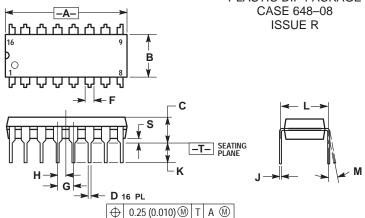
PACKAGE DIMENSIONS



- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
 3. DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL.
 4. DIMENSION F MAY NARROW TO 0.76 (0.030) WHERE THE LEAD ENTERS THE CERAMIC BODY.

	INC	HES	MILLIN	IETERS	
DIM	MIN	MAX	MIN	MAX	
Α	0.750	0.785	19.05	19.93	
В	0.240	0.295	6.10	7.49	
С		0.200		5.08	
D	0.015	0.020	0.39	0.50	
Е	0.050	BSC	1.27 BSC		
F	0.055	0.065	1.40	1.65	
G	0.100	BSC	2.54 BSC		
Н	0.008	0.015	0.21	0.38	
K	0.125	0.170	3.18	4.31	
L	0.300	BSC	7.62 BSC		
M	0°	15°	0 °	15°	
N	0.020	0.040	0.51	1.01	





- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
 3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
 4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.
 5. ROUNDED CORNERS OPTIONAL.

	INC	HES	MILLIN	IETERS	
DIM	MIN	MAX	MIN	MAX	
Α	0.740	0.770	18.80	19.55	
В	0.250	0.270	6.35	6.85	
С	0.145	0.175	3.69	4.44	
D	0.015	0.021	0.39	0.53	
F	0.040	0.70	1.02	1.77	
G	0.100	BSC	2.54	BSC	
Н	0.050	BSC	1.27 BSC		
J	0.008	0.015	0.21	0.38	
K	0.110	0.130	2.80	3.30	
L	0.295	0.305	7.50	7.74	
M	0°	10 °	0 °	10 °	
S	0.020	0.040	0.51	1.01	

Notes

Notes

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